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Quarterly Reliability Monitoring Results

Quarters: Q1/2022 to Q4/2023

Based on structural similarity

Supplier		User Part Number						
Nexperia B.V. Name of Laboratory Assembly reliability labs Based on AEC-Q101 Test		PIMP32PAS-Q Part Description						
		MCD package						
		Test Conditions	Duration	# Lots	# Quantity	# Rejects		
			TEST					
	Pre- and Post-Stress							
# E1	Electrical Test	Tamb = 25 °C	N/A	see below	all parts	see below		
		JESD22-A113 Bake Tamb = 125 °C	24 hours					
	PC	Soak Tamb = $85 ^{\circ}$ C, RH = 85%	168 hours					
# A1	Preconditioning	Reflow soldering	3 cycles	464	20960	0		
		MIL-STD-750-1						
	HTRB	M1039 Method A						
	High Temperature Reverse	Tj = Tjmax, Vr = 100% of max. datasheet						
# B1	Bias	reverse voltage	1000 hours	415	18680	0		
	TC	JESD22-A104						
# A4	Temperature Cycling	-65 °C to Tjmax, not to exceed 150°C	1000 cycles	116	5240	0		
	UHAST	JESD22-A118						
# A3 or	Unbiased HAST	Tamb = $130 ^{\circ}$ C, RH = $85 ^{\circ}$	— 96 hours	116	5240	0		
		JESD22-A102						
	AC	Tamb = 121 °C, RH = 100 %						
# A3 alt	Autoclave	Pressure = 205 kPa (29.7 psia)						
	H3TRB	JESD22-A101						
	High Humidity High	Tamb = 85 °C, RH = 85%, VR = 80 % of						
# A2 alt	Temperature Reverse Bias	-	1000 hours	116	5240	0		
		MIL-STD-750 Method 1037						
	IOL	ton = toff, devices powered to insure ΔT_j =						
# A5	Intermittent Operating Life	100 °C IOF 15000 CYCles	1000 hours	116	5240	0		
	RSH	JESD22-A111						
# C8	Resistance to Solder Heat		10 s	n.a.	n.a.	n.a.		
	SD			-	-			
# C10	Solderability	J-STD-002		86	2580	0		

[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

Wafer Fab	Technology	Quantity	Rejects	Failure Rate (FIT)	MTTF (hrs)
Nexperia DHAM	Small Signal Bipolar Transistor	18680	0	0,23	4,40E+09

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